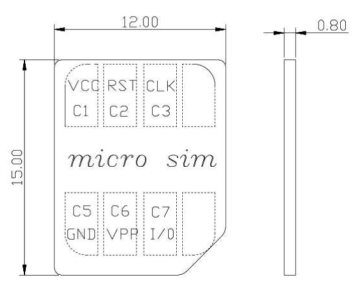


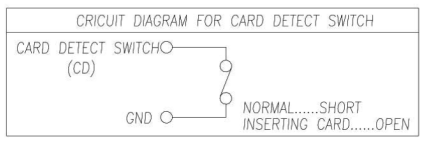
SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

NOTES:
MATERIAL:
 Insulator: High Temperature Thermoplastic,UL 94V-0.
 Contact: Copper Alloy
 Shell: STAINLESS
PLATING:
 Contact: Plated 30u'' Ni Overall Contact Au IU
 Shell: Plated 30u'' Ni Overall
 Plated 1u''Au Selective Contact Area
Electrical:
 Current Rating :0.5mA AC/DC max.
 Voltage Rating :125V AC/DC
 Ambient Temperature Range :-20° C+60° C
 Storage Temperature Range :-40° C+70° C
 Ambient Humidity Range :95% R.H. Max.
 Contact Resistance:100mΩmax.
 Insulation Resistance:1000MΩmin./500VDC
 Mating Cycles:10000 Insertions
 Temperature: 260° C ±5°



MICRO SIM CARD

■ CIRCUIT TRACE KEEP OUT AREA
 ■ SMT SOLDER AREA
 THERE SHOULD NOT BE ANY CIRCUITRIES
 IN THE LAYOUT SPACE OF THE PRODUCTS.
RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05



SHENZHEN KINGHELM ELECTRONIC CO., LTD.		WWW.BDS666.COM	
KH-SIM1616-6PIN		0755-83044319	
TOLERANCE UNSPECIFIED		TITLE	MICRO SIM PUSH 6P
X. ±0.30	X. ±3°	PART NUMBER	C3P206J2640
.X ±0.25	.X ±2°	DRAWING NUMBER	
.XX ±0.20	.XX ±1°	INTT	mm
.XXX ±0.05	.XXX ±0.5°	SCALE	1:1
		SHEET	1/1
		DATE	2014/5/27
		DESIGNED	Luo Zhenefu
		CHECKED	Luo Libin
		APPROVED	Zhang Huavu